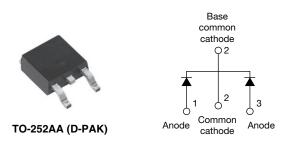
Vishay Semiconductors



Hyperfast Rectifier, 2 x 4 AFRED Pt®



PRODUCT SUMMARY								
Package	TO-252AA (D-PAK)							
I _{F(AV)}	2 x 4 A							
V _R	200 V							
V _F at I _F	0.71 V							
t _{rr} (typ.)	23 ns							
T _J max.	175 °C							
Diode variation	Common cathode							

FEATURES

- Hyperfast recovery time
- 175 °C max. operating junction temperature
- Output rectification freewheeling
- \bullet Low forward voltage drop reduced Q_{rr} and soft recovery
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS inverters or as freewheeling diodes. Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS						
Peak repetitive reverse voltage	V _{RRM}		200	V						
Average rectified forward current	I _{F(AV)}	T _C = 164 °C	8	^						
Non-repetitive peak surge current per leg	I _{FSM}	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	80	A						
Operating junction and storage temperatures	T _J , T _{Stg}		-65 to +175	°C						

ELECTRICAL SPECIFICATIONS (T _J = 25 $^{\circ}$ C unless otherwise specified)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Breakdown voltage, blocking voltage	V _{BR} , V _R	I _R = 100 μA	200	-	-				
Forward voltage per leg		$I_F = 4 A$	-	0.87	0.95				
	V _F	I _F = 8 A		0.95	1.10	V			
		I _F = 4 A, T _J = 150 °C	150 °C - 0.71		0.80				
		I _F = 8 A, T _J = 150 °C	-	0.8	1.0				
		$V_{R} = V_{R}$ rated	-	-	4				
Reverse leakage current per leg	I _R	$T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$	-	-	40	μA			
		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	80				
Junction capacitance per leg	CT	V _R = 200 V	-	17	-	pF			
Series inductance	LS	Measured lead to lead 5 mm from package body	-	8	-	nH			



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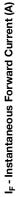


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DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)										
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS			
Reverse recovery time		$I_F = 1 \text{ A}, dI_F/dt = 10$	00 A/µs, V _R = 30 V	-	23	27				
	t _{rr}	T _J = 25 °C		-	20	-	ns			
		T _J = 125 °C	I _F = 4 A dI _F /dt = 200 A/µs V _R = 160 V	-	27	-				
Poak rocovary ourrant	I _{RRM}	T _J = 25 °C		-	2	-	А			
Peak recovery current		T _J = 125 °C		-	3.4	-	A .			
Deverse verse vers	0	T _J = 25 °C		-	20	-	nC			
Reverse recovery charge	Q _{rr}	T _J = 125 °C		-	46	-	nc			

THERMAL - MECHANICAL SPECIFICATIONS									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS			
Maximum junction and storage temperature range	T _J , T _{Stg}		-65	-	175	°C			
Thermal resistance, per leg	R _{thJC}		-	2.7	3.2	°C/W			
junction to case per device			-	1.35	1.6	0/10			
A				0.3		g			
Approximate weight				0.01					
Marking device		Case style TO-252AA (D-PAK)	8CWH02FN						



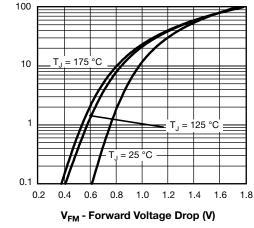
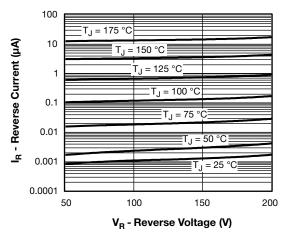
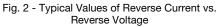


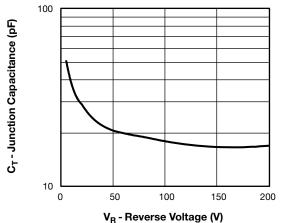
Fig. 1 - Typical Forward Voltage Drop Characteristics

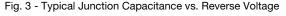






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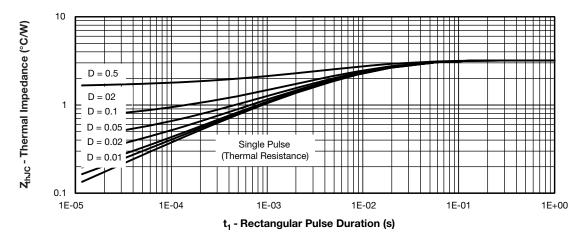
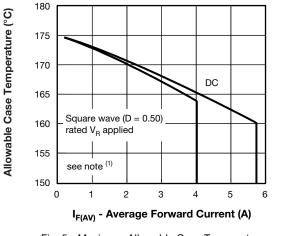
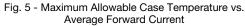


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics



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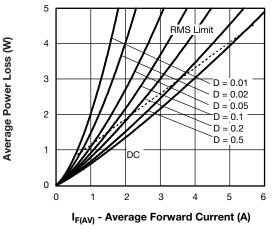


Fig. 6 - Forward Power Loss Characteristics

Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;

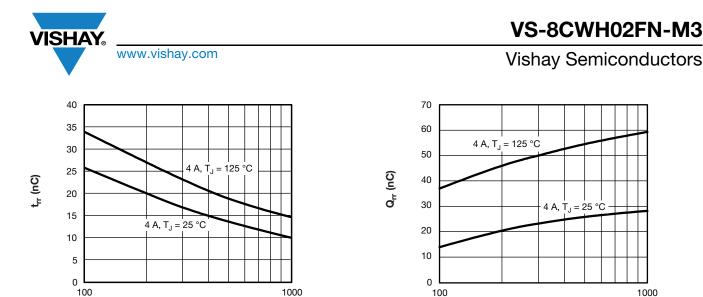
 $\begin{array}{l} \mathsf{Pd} = \mathsf{forward} \ \mathsf{power} \ \mathsf{loss} = \mathsf{I}_{\mathsf{F}(\mathsf{AV})} \times \mathsf{V}_{\mathsf{FM}} \ \mathsf{at} \ (\mathsf{I}_{\mathsf{F}(\mathsf{AV})}/\mathsf{D}) \ (\mathsf{see} \ \mathsf{fig.} \ \mathsf{6}); \\ \mathsf{Pd}_{\mathsf{REV}} = \mathsf{inverse} \ \mathsf{power} \ \mathsf{loss} = \mathsf{V}_{\mathsf{R1}} \times \mathsf{I}_{\mathsf{R}} \ (\mathsf{1} - \mathsf{D}); \ \mathsf{I}_{\mathsf{R}} \ \mathsf{at} \ \mathsf{V}_{\mathsf{R1}} = \mathsf{rated} \ \mathsf{V}_{\mathsf{R}} \end{array}$

Revision: 05-Oct-16

3

Document Number: 93261

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dl_Fdt (A/µs)

Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt



Fig. 8 - Typical Stored Charge vs. dl_F/dt

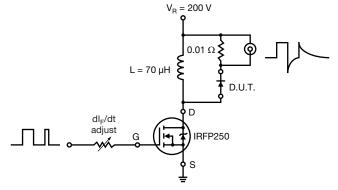
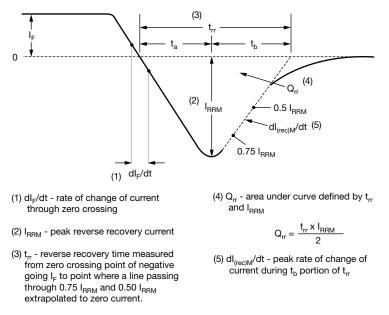
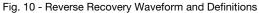


Fig. 9 - Reverse Recovery Parameter Test Circuit





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ORDERING INFORMATION TABLE

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Desires and		•	•					TDI	
Device code	VS-	8	С	W	н	02	FN	TRL	-M3
	1	2	3	4	5	6	7	8	9
	1	- Visl	nay Sen	nicondu	ctors pro	oduct			
	2	- Cur	rent rati	ng (8 =	8 A)				
	3	- Circ	uit conf	iguratio	า:				
		C =	commo	on catho	de				
	4	- Pac	kage id	entifier:					
		VV =	D-PAK	<u> </u>					
	5	- H=	hyperfa	ast recov	/ery				
	6	- Vol	age rati	ng (02 =	= 200 V))			
	7	- FN	= TO-25	52AA					
	8	• N	one = tu	ibe					
		• TI	R = tape	e and re	el				
		• TI	RL = tap	be and r	eel (left	orienteo	d)		
		• TI	RR = tap	pe and r	eel (righ	nt orient	ed)		
	9	- Env	ironmer	ntal digit	:				
		-M3	= halog	gen-free	, RoHS-	complia	ant and	termina	tions le

ORDERING INFORMATION (Example)										
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION							
VS-8CWH02FN-M3	75	3000	Antistatic plastic tube							
VS-8CWH02FNTR-M3	2000	2000	13" diameter reel							
VS-8CWH02FNTRL-M3	3000	3000	13" diameter reel							
VS-8CWH02FNTRR-M3	3000	3000	13" diameter reel							

LINKS TO RELATED DOCUMENTS							
Dimensions	www.vishay.com/doc?95627						
Part marking information	www.vishay.com/doc?95176						
Packaging information	www.vishay.com/doc?95033						
SPICE model	www.vishay.com/doc?95375						





D-PAK (TO-252AA) "M"

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES		SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STNIDUL	MIN.	MAX.	MIN.	MAX.	NOTES		STIVIDUL	MIN.	MAX.	MIN.	MAX.	NOTES
А	2.18	2.39	0.086	0.094			е	2.29	BSC	0.090	BSC	
A1	-	0.13	-	0.005			Н	9.40	10.41	0.370	0.410	
b	0.64	0.89	0.025	0.035			L	1.40	1.78	0.055	0.070	
b2	0.76	1.14	0.030	0.045			L1	2.74	BSC	0.108	REF.	
b3	4.95	5.46	0.195	0.215	3		L2	0.51 BSC		0.020 BSC		
с	0.46	0.61	0.018	0.024			L3	0.89	1.27	0.035	0.050	3
c2	0.46	0.89	0.018	0.035			L4	-	1.02	-	0.040	
D	5.97	6.22	0.235	0.245	5		L5	1.14	1.52	0.045	0.060	2
D1	5.21	-	0.205	-	3		Ø	0°	10°	0°	10°	
E	6.35	6.73	0.250	0.265	5		Ø1	0°	15°	0°	15°	
E1	4.32	-	0.170	-	3		Ø2	25°	35°	25°	35°	

Notes

⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994

⁽²⁾ Lead dimension uncontrolled in L5

⁽³⁾ Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad

(4) Section C - C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip

(5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

⁽⁶⁾ Dimension b1 and c1 applied to base metal only

⁽⁷⁾ Datum A and B to be determined at datum plane H

⁽⁸⁾ Outline conforms to JEDEC[®] outline TO-252AA



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